













SN74AVC2T45 SCES531K - DECEMBER 2003 - REVISED APRIL 2015

## SN74AVC2T45 2-Bit, 2-Supply, Bus Transceiver With Configurable Level-Shifting and Translation and 3-State Outputs

#### **Features**

- Available in the Texas Instruments NanoFree™ Package
- V<sub>CC</sub> Isolation
- 2-Rail Design
- I/Os Are 4.6 V Tolerant
- Partial-Power-Down Mode Operation
- Max Data Rates
  - 500 Mbps (1.8 V to 3.3 V)
  - 320 Mbps (<1.8 V to 3.3 V)
  - 320 Mbps (Level-Shifting to 2.5 V or 1.8 V)
  - 280 Mbps (Level-Shifting to 1.5 V)
  - 240 Mbps (Level-Shifting to 1.2 V)
- Latch-Up Performance Exceeds 100 mA Per JESD 78, Class II
- ESD Protection Exceeds JESD 22

### **Applications**

- **Smartphones**
- Servers
- Desktop PCs and Notebooks
- Other Portable Devices

### 3 Description

This 2-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A ports are designed to track  $V_{\text{CCA}}$  and accepts any supply voltage from 1.2 V to 3.6 V. The B ports are designed to track V<sub>CCB</sub> and accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation and level-shifting between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

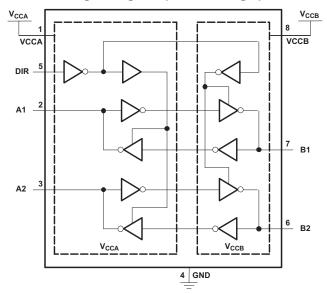
The SN74AVC2T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR pin) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess leakage current on the internal CMOS structure.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)   |  |  |  |
|-------------|-----------|-------------------|--|--|--|
|             | SSOP (8)  | 2.95 mm × 2.80 mm |  |  |  |
| SN74AVC2T45 | VSSOP (8) | 2.30 mm × 2.00 mm |  |  |  |
|             | DSBGA (8) | 1.89 mm × 0.89 mm |  |  |  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

### Logic Diagram (Positive Logic)



(1) Pin numbers are for the DCT and DCU packages only.



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### 4 Revision History

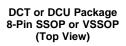
### Changes from Revision J (June 2007) to Revision K

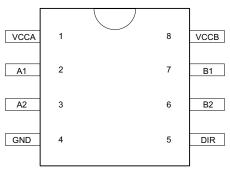
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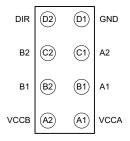


### 5 Pin Configuration and Functions





#### YZP Package 8-Pin DSBGA (Top View)



### **Pin Functions**

|      | PIN                 |                |   |
|------|---------------------|----------------|---|
| NAME | NO.<br>(SSOP/VSSOP) | NO.<br>(DSBGA) | DESCRIPTION   |
| VCCA | 1                   | A1             | Supply Voltage A  |
| VCCB | 8                   | A2             | Supply Voltage B  |
| GND  | 4                   | D1             | Ground  |
| A1   | 2                   | B1             | Output or input depending on state of DIR. Output level depends on V <sub>CCA</sub> . |
| A2   | 3                   | C1             | Output or input depending on state of DIR. Output level depends on V <sub>CCA</sub> . |
| B1   | 7                   | B2             | Output or input depending on state of DIR. Output level depends on V <sub>CCB</sub> . |
| B2   | 6                   | C2             | Output or input depending on state of DIR. Output level depends on V <sub>CCB</sub> . |
| DIR  | 5                   | D2             | Direction Pin, Connect to GND or to VCCA  |



### 6 Specifications

### 6.1 Absolute Maximum Ratings<sup>(1)</sup>

over operating free-air temperature range (unless otherwise noted)

|                   |  |                    | MIN  | MAX                    | UNIT |  |
|-------------------|--|--------------------|------|------------------------|------|--|
| $V_{CCA} V_{CCB}$ | Supply voltage   |                    | -0.5 | 4.6                    | V    |  |
|                   |  | IO ports (A port)  | -0.5 | 4.6                    |      |  |
| $V_{I}$           | Input voltage (2)  | IO ports (B port)  | -0.5 | 4.6                    | V    |  |
|                   |  | Control inputs     | -0.5 | 4.6                    |      |  |
| V                 | Voltage applied to any output in the high-impedance or power-off state (2) | A port             | -0.5 | 4.6                    |      |  |
| Vo                | off state (2)  | B port             | -0.5 | 4.6                    | V    |  |
| V                 | Valence and lied to any output in the bight and any attack (2) (3)         | A port             | -0.5 | V <sub>CCA</sub> + 0.5 | V    |  |
| Vo                | Voltage applied to any output in the high or low state (2) (3)             | B port             | -0.5 | V <sub>CCB</sub> + 0.5 | V    |  |
| I <sub>IK</sub>   | Input clamp current  | V <sub>I</sub> < 0 |      | <b>–</b> 50            | mA   |  |
| I <sub>OK</sub>   | Output clamp current   | V <sub>O</sub> < 0 |      | <b>–</b> 50            | mA   |  |
| Io                | Continuous output current  |                    |      | ±50                    | mA   |  |
|                   | Continuous current through VCCA, VCCB, or GND                              |                    |      | ±100                   | mA   |  |
| T <sub>stg</sub>  | Storage temperature  |                    | -65  | 150                    | °C   |  |

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|                    |                               |  | VALUE | UNIT |
|--------------------|-------------------------------|--|-------|------|
|                    |                               | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 (1)                         | ±8000 |      |
| V <sub>(ESD)</sub> | (ESD) Electrostatic discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±1000 | V    |
|                    |                               | Machine Model (MM), Per JEDEC specification JESD22-A115-A                      | ±200  |      |

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

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<sup>(2)</sup> The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

<sup>(3)</sup> The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current ratings are observed.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



### 6.3 Recommended Operating Conditions (1)(2)(3)

|                  |                             |  | V <sub>CCI</sub> <sup>(4)</sup> | V <sub>CCO</sub> (5) | MIN                                    | MAX                                    | UNIT |
|------------------|-----------------------------|--|---------------------------------|----------------------|--|--|------|
| V <sub>CCA</sub> | Supply voltage              |  |                                 |                      | 1.2                                    | 3.6                                    | V    |
| V <sub>CCB</sub> | Supply voltage              |  |                                 |                      | 1.2                                    | 3.6                                    | V    |
|                  | High-level                  | (2)  | 1.2 V to 1.95 V                 |                      | V <sub>CCI</sub> <sup>(4)</sup> × 0.65 |  |      |
| $V_{IH}$         | input voltage               | Data inputs <sup>(2)</sup>                           | 1.95 V to 2.7 V                 |                      | 1.6                                    |  | V    |
|                  |                             |  | 2.7 V to 3.6 V                  |                      | 2                                      |  |      |
|                  | Low-level                   | (2)  | 1.2 V to 1.95 V                 |                      |  | V <sub>CCI</sub> <sup>(4)</sup> × 0.35 |      |
| $V_{IL}$         | input voltage               | Data inputs <sup>(2)</sup>                           | 1.95 V to 2.7 V                 |                      |  | 0.7                                    | V    |
|                  |                             |  | 2.7 V to 3.6 V                  |                      |  | 0.8                                    |      |
|                  |                             |  | 1.2 V to 1.95 V                 |                      | V <sub>CCA</sub> × 0.65                |  |      |
| $V_{IH}$         | High-level<br>input voltage | DIR (referenced to V <sub>CCA</sub> ) <sup>(3)</sup> | 1.95 V to 2.7 V                 |                      | 1.6                                    |  | V    |
|                  | input voltage               | (referenced to ACCV)                                 | 2.7 V to 3.6 V                  |                      | 2                                      |  |      |
|                  |                             |  |                                 |                      |  | $V_{CCA} \times 0.35$                  |      |
| $V_{IL}$         | Low-level input voltage     | DIR (referenced to V <sub>CCA</sub> ) <sup>(3)</sup> | 1.95 V to 2.7 V                 |                      |  | 0.7                                    | V    |
|                  |                             | (Colorellos to VCCA)                                 | 2.7 V to 3.6 V                  |                      |  | 0.8                                    |      |
| VI               | Input voltage               |  |                                 |                      | 0                                      | 3.6                                    | V    |
| Vo               | Output voltage              | Active state   |                                 |                      | 0                                      | V <sub>CCO</sub> (5)                   | V    |
| v <sub>O</sub>   | Output voltage              | 3-state  |                                 |                      | 0                                      | 3.6                                    | V    |
|                  |                             |  |                                 | 1.2 V                |  | -3                                     |      |
|                  |                             |  |                                 | 1.4 V to 1.6 V       |  | -6                                     |      |
| $I_{OH}$         | High-level output           | current  |                                 | 1.65 V to 1.95 V     |  | -8                                     | mA   |
|                  |                             |  |                                 | 2.3 V to 2.7 V       |  | -9                                     |      |
|                  |                             |  |                                 | 3 V to 3.6 V         |  | -12                                    |      |
|                  |                             |  |                                 | 1.2 V                |  | 3                                      |      |
|                  |                             |  |                                 | 1.4 V to 1.6 V       |  | 6                                      |      |
| $I_{OL}$         | Low-level output current    |  |                                 | 1.65 V to 1.95 V     |  | 8                                      | mA   |
|                  |                             |  |                                 | 2.3 V to 2.7 V       |  | 9                                      |      |
|                  |                             |  |                                 | 3 V to 3.6 V         |  | 12                                     |      |
| Δt/Δv            | Input transition ris        | e or fall rate                                       |                                 |                      |  | 5                                      | ns/V |
| T <sub>A</sub>   | Operating free-air          | temperature  |                                 |                      | -40                                    | 85                                     | °C   |

<sup>(1)</sup> All unused data inputs of the device must be held at V<sub>CCI</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, SCBA004.
(2) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCI</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCI</sub> × 0.3 V.
(3) For V<sub>CCI</sub> values not specified in the data sheet, V<sub>IH</sub> min = V<sub>CCA</sub> × 0.7 V, V<sub>IL</sub> max = V<sub>CCA</sub> × 0.3 V.
(4) V<sub>CCI</sub> is the voltage associated with the input port supply VCCA or VCCB.
(5) V<sub>CCO</sub> is the voltage associated with the output port supply VCCA or VCCB.



#### 6.4 Thermal Information

|                      |  |            | SN74AVC2T45 |             |      |  |  |  |
|----------------------|--|------------|-------------|-------------|------|--|--|--|
|                      | THERMAL METRIC <sup>(1)</sup>                | DCT (SSOP) | DCU (VSSOP) | YZP (DSBGA) | UNIT |  |  |  |
|                      |  | 8 PINS     | 8 PINS      | 8 PINS      |      |  |  |  |
| $R_{\theta JA}$      | Junction-to-ambient thermal resistance       | 194.4      | 199.3       | 105.8       |      |  |  |  |
| $R_{\theta JC(top)}$ | Junction-to-case (top) thermal resistance    | 124.7      | 76.2        | 1.6         |      |  |  |  |
| $R_{\theta JB}$      | Junction-to-board thermal resistance         | 106.8      | 80.6        | 10.8        | °C/W |  |  |  |
| $\Psi_{JT}$          | Junction-to-top characterization parameter   | 49.8       | 7.1         | 3.1         |      |  |  |  |
| ΨЈВ                  | Junction-to-board characterization parameter | 105.8      | 80.1        | 10.8        |      |  |  |  |

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

#### 6.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (1) (2)

| DAD                | AMETER                         | TEST COND                                | ITIONS                | V                | V                |     | T <sub>A</sub> = 25°C |       | -40°C to 85              | 5°C  | UNIT |  |
|--------------------|--------------------------------|--|-----------------------|------------------|------------------|-----|-----------------------|-------|--------------------------|------|------|--|
| PARA               | AIVIETER                       | TEST COND                                | IIIONS                | V <sub>CCA</sub> | V <sub>CCB</sub> | MIN | TYP                   | MAX   | MIN                      | MAX  | UNIT |  |
|                    |                                | $I_{OH} = -100 \mu A$                    |                       | 1.2 V to 3.6 V   | 1.2 V to 3.6 V   |     |                       |       | V <sub>CCO</sub> - 0.2 V |      |      |  |
|                    |                                | $I_{OH} = -3 \text{ mA}$                 |                       | 1.2 V            | 1.2 V            |     | 0.95                  |       |                          |      |      |  |
| v (5               | 3)                             | $I_{OH} = -6 \text{ mA}$                 | \/ \/                 | 1.4 V            | 1.4 V            |     |                       |       | 1.05                     |      | V    |  |
| V <sub>OH</sub> (  | -,                             | $I_{OH} = -8 \text{ mA}$                 | $V_I = V_{IH}$        | 1.65 V           | 1.65 V           |     |                       |       | 1.2                      |      | V    |  |
|                    |                                | $I_{OH} = -9 \text{ mA}$                 |                       | 2.3 V            | 2.3 V            |     |                       |       | 1.75                     |      |      |  |
|                    |                                | $I_{OH} = -12 \text{ mA}$                |                       | 3 V              | 3 V              |     |                       |       | 2.3                      |      |      |  |
|                    |                                | $I_{OL} = 100 \mu A$                     |                       | 1.2 V to 3.6 V   | 1.2 V to 3.6 V   |     |                       |       |                          | 0.2  |      |  |
|                    |                                | $I_{OL} = 3 \text{ mA}$                  |                       | 1.2 V            | 1.2 V            |     | 0.25                  |       |                          |      |      |  |
| V <sub>OL</sub> (3 | 3)                             | $I_{OL} = 6 \text{ mA}$                  | $V_I = V_{IL}$        | 1.4 V            | 1.4 V            |     |                       |       |                          | 0.35 | V    |  |
| vOL ,              | ,                              | $I_{OL} = 8 \text{ mA}$                  | VI = VIL              | 1.65 V           | 1.65 V           |     |                       |       |                          | 0.45 | V    |  |
|                    |                                | $I_{OL} = 9 \text{ mA}$                  |                       | 2.3 V            | 2.3 V            |     |                       |       |                          | 0.55 |      |  |
|                    |                                | I <sub>OL</sub> = 12 mA                  |                       | 3 V              | 3 V              |     |                       |       |                          | 0.7  |      |  |
| I                  | DIR                            | V <sub>I</sub> = V <sub>CCA</sub> or GND |                       | 1.2 V to 3.6 V   | 1.2 V to 3.6 V   |     | ±0.025                | ±0.25 |                          | ±1   | μΑ   |  |
|                    | A port                         | $V_{I}$ or $V_{O} = 0$ to 3.6 V          |                       | 0 V              | 0 to 3.6 V       |     | ±0.1                  | ±1    |                          | ±5   | μA   |  |
| I <sub>off</sub>   | B port                         | $V_1 \cup V_0 = 0 \cup 3$                | 0.0 V                 | 0 to 3.6 V       | 0 V              |     | ±0.1                  | ±1    |                          | ±5   | μΑ   |  |
| I <sub>OZ</sub>    | B port                         | $V_O = V_{CCO}$ or G                     | ND,                   | 0 V              | 3.6 V            |     | ±0.5                  | ±2.5  |                          | ±5   |      |  |
| (3)                | A port                         | $V_I = V_{CCI}$ or $GN$                  | D                     | 3.6 V            | 0 V              |     | ±0.5                  | ±2.5  |                          | ±5   | μA   |  |
|                    |                                |  |                       | 1.2 V to 3.6 V   | 1.2 V to 3.6 V   |     |                       |       |                          | 10   |      |  |
| I <sub>CCA</sub> ( | 3)                             | $V_I = V_{CCI}$ or $GN$                  | D, $I_0 = 0$          | 0 V              | 3.6 V            |     |                       |       |                          | -2   | μΑ   |  |
|                    |                                |  |                       | 3.6 V            | 0 V              |     |                       |       |                          | 10   |      |  |
|                    |                                |  |                       | 1.2 V to 3.6 V   | 1.2 V to 3.6 V   |     |                       |       |                          | 10   |      |  |
| I <sub>CCB</sub> ( | 3)                             | $V_I = V_{CCI}$ or $GN$                  | D, $I_0 = 0$          | 0 V              | 3.6 V            |     |                       |       |                          | 10   | μΑ   |  |
|                    |                                |  |                       | 3.6 V            | 0 V              |     |                       |       |                          | -2   |      |  |
| I <sub>CCA</sub> + | - I <sub>ССВ</sub><br>Гable 1) | V <sub>I</sub> = V <sub>CCI</sub> or GN  | D, I <sub>O</sub> = 0 | 1.2 V to 3.6 V   | 1.2 V to 3.6 V   |     |                       |       |                          | 20   | μΑ   |  |
| Cı                 | Control inputs                 | V <sub>I</sub> = 3.3 V or GN             | ID                    | 3.3 V            | 3.3 V            |     | 2.5                   |       |                          |      | pF   |  |
| C <sub>io</sub>    | A or B<br>port                 | V <sub>O</sub> = 3.3 V or G              | ND                    | 3.3 V            | 3.3 V            |     | 6                     |       |                          |      | pF   |  |

 $V_{CCO}$  is the voltage associated with the output port supply VCCA or VCCB.  $V_{CCI}$  is the voltage associated with the input port supply VCCA or VCCB.  $V_{OH}$ : Output High Voltage;  $V_{OL}$ : Output Low Voltage;  $V_{OZ}$ : Hi-Z Output Current;  $V_{CCA}$ : Supply A Current;  $V_{CCB}$ : Supply B Current



Table 1. Typical Total Static Power Consumption ( $I_{CCA} + I_{CCB}$ )

| V                |      |       | Vc    | CA    |       |       | UNIT |  |
|------------------|------|-------|-------|-------|-------|-------|------|--|
| V <sub>CCB</sub> | 0 V  | 1.2 V | 1.5 V | 1.8 V | 2.5 V | 3.3 V | UNIT |  |
| 0 V              | 0    | <0.5  | <0.5  | <0.5  | <0.5  | <0.5  |      |  |
| 1.2 V            | <0.5 | <1    | <1    | <1    | <1    | 1     |      |  |
| 1.5 V            | <0.5 | <1    | <1    | <1    | <1    | 1     |      |  |
| 1.8 V            | <0.5 | <1    | <1    | <1    | <1    | <1    | μΑ   |  |
| 2.5 V            | <0.5 | 1     | <1    | <1    | <1    | <1    |      |  |
| 3.3 V            | <0.5 | 1     | <1    | <1    | <1    | <1    |      |  |

### 6.6 Switching Characteristics: V<sub>CCA</sub> = 1.2 V

over recommended operating free-air temperature range,  $V_{CCA} = 1.2 \text{ V}$  (see Figure 11)

| PARAMETER                                      | FROM    | то       | V <sub>CCB</sub> = 1.2 V | V <sub>CCB</sub> = 1.5 V | V <sub>CCB</sub> = 1.8 V | V <sub>CCB</sub> = 2.5 V | V <sub>CCB</sub> = 3.3 V | UNIT |  |
|--|---------|----------|--------------------------|--------------------------|--------------------------|--------------------------|--------------------------|------|--|
| PARAMETER                                      | (INPUT) | (OUTPUT) | TYP                      | TYP                      | TYP                      | TYP                      | TYP                      | UNII |  |
| t <sub>PLH</sub> <sup>(1)</sup>                | А       | В        | 3.1                      | 2.6                      | 2.4                      | 2.2                      | 2.2                      | 20   |  |
| t <sub>PHL</sub> <sup>(1)</sup>                | A       | Б        | 3.1                      | 2.6                      | 2.4                      | 2.2                      | 2.2                      | ns   |  |
| t <sub>PLH</sub> <sup>(1)</sup>                | В       | Δ.       | 3.4                      | 3.1                      | 3                        | 2.9                      | 2.9                      |      |  |
| t <sub>PHL</sub> <sup>(1)</sup>                | В       | A        | 3.4                      | 3.1                      | 3                        | 2.9                      | 2.9                      | ns   |  |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR     | ^        | 5.2                      | 5.2                      | 5.1                      | 5                        | 4.8                      | 20   |  |
| t <sub>PLZ</sub> (1)                           | DIK     | Α        | 5.2                      | 5.2                      | 5.1                      | 5                        | 4.8                      | ns   |  |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DID     |          | 5                        | 4                        | 3.8                      | 2.8                      | 3.2                      |      |  |
| t <sub>PLZ</sub> (1)                           | DIR     | В        | 5                        | 4                        | 3.8                      | 2.8                      | 3.2                      | ns   |  |
| t <sub>PZH</sub> (1) (2)                       | DID     | Δ.       | 8.4                      | 7.1                      | 6.8                      | 5.7                      | 6.1                      |      |  |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR     | Α        | 8.4                      | 7.1                      | 6.8                      | 5.7                      | 6.1                      | ns   |  |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DID     | В        | 8.3                      | 7.8                      | 7.5                      | 7.2                      | 7                        | 20   |  |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR     | В        | 8.3                      | 7.8                      | 7.5                      | 7.2                      | 7                        | ns   |  |

 $t_{PLH}$ : Low-to-high Propagation Delay;  $t_{PHL}$ : High-to-Low Propagation Delay;  $t_{PHZ}$ : High-to-Hi-Z Propagation Delay;  $t_{PLZ}$ : Low-to-Hi-Z Propagation Delay;  $t_{PZH}$ : Hi-Z-to-High Propagation Delay;  $t_{PZL}$ : Hi-Z-to-Low Propagation Delay The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.

### 6.7 Switching Characteristics: V<sub>CCA</sub> = 1.5 V ±0.1 V

over recommended operating free-air temperature range,  $V_{CCA} = 1.5 \text{ V} \pm 0.1 \text{ V}$  (see Figure 11)

| PARAMETER                                      | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.2 V | V <sub>CCB</sub> = ± 0.1 | 1.5 V<br>I V | V <sub>CCB</sub> = 1.8 V<br>± 0.15 V |      | V <sub>CCB</sub> = 2.5 V<br>± 0.2 V |      | V <sub>CCB</sub> = 3.3 V<br>± 0.3 V |      | UNIT |
|--|-----------------|----------------|--------------------------|--------------------------|--------------|--------------------------------------|------|-------------------------------------|------|-------------------------------------|------|------|
|  |                 | (001701)       | TYP                      | MIN                      | MAX          | MIN                                  | MAX  | MIN                                 | MAX  | MIN                                 | MAX  |      |
| t <sub>PLH</sub> <sup>(1)</sup>                | А               | В              | 2.8                      | 0.7                      | 5.4          | 0.5                                  | 4.6  | 0.4                                 | 3.7  | 0.3                                 | 3.5  | 20   |
| t <sub>PHL</sub> <sup>(1)</sup>                | Λ               | Ь              | 2.8                      | 0.7                      | 5.4          | 0.5                                  | 4.6  | 0.4                                 | 3.7  | 0.3                                 | 3.5  | ns   |
| t <sub>PLH</sub> <sup>(1)</sup>                | 0               | ۸              | 2.7                      | 0.8                      | 5.4          | 0.7                                  | 5.2  | 0.6                                 | 4.9  | 0.5                                 | 4.7  | 20   |
| t <sub>PHL</sub> <sup>(1)</sup>                | В               | Α              | 2.7                      | 0.8                      | 5.4          | 0.7                                  | 5.2  | 0.6                                 | 4.9  | 0.5                                 | 4.7  | ns   |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIB             | ۸              | 3.9                      | 1.3                      | 8.5          | 1.3                                  | 7.8  | 1.1                                 | 7.7  | 1.4                                 | 7.6  | 20   |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIR             | Α              | 3.9                      | 1.3                      | 8.5          | 1.3                                  | 7.8  | 1.1                                 | 7.7  | 1.4                                 | 7.6  | ns   |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR             | В              | 4.7                      | 1.1                      | 7            | 1.4                                  | 6.9  | 1.2                                 | 6.9  | 1.7                                 | 7.1  | 20   |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIK             | Ь              | 4.7                      | 1.1                      | 7            | 1.4                                  | 6.9  | 1.2                                 | 6.9  | 1.7                                 | 7.1  | ns   |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DID             | ۸              | 7.4                      |                          | 12.4         |                                      | 12.1 |                                     | 11.8 |                                     | 11.8 |      |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | DIR A          | 7.4                      |                          | 12.4         |                                      | 12.1 |                                     | 11.8 |                                     | 11.8 | ns   |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DIB             | ID D           | 6.7                      |                          | 13.9         |                                      | 12.4 |                                     | 11.4 |                                     | 11.1 | 20   |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | В              | 6.7                      |                          | 13.9         |                                      | 12.4 |                                     | 11.4 |                                     | 11.1 | ns   |

 $t_{PLH}$ : Low-to-high Propagation Delay;  $t_{PHL}$ : High-to-Low Propagation Delay;  $t_{PHZ}$ : High-to-Hi-Z Propagation Delay;  $t_{PLZ}$ : Low-to-Hi-Z Propagation Delay;  $t_{PZH}$ : Hi-Z-to-High Propagation Delay;  $t_{PZL}$ : Hi-Z-to-Low Propagation Delay The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.



### 6.8 Switching Characteristics: $V_{CCA} = 1.8 \text{ V} \pm 0.15 \text{ V}$

over recommended operating free-air temperature range, V<sub>CCA</sub> = 1.8 V ± 0.15 V (see Figure 11)

| PARAMETER                                      | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.2 V | V <sub>CCB</sub> = ± 0.1 | 1.5 V<br>I V | V <sub>CCB</sub> = 1.8 V<br>± 0.15 V |      | V <sub>CCB</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CCB</sub> = 3.3 V<br>± 0.3 V |     | UNIT |
|--|-----------------|----------------|--------------------------|--------------------------|--------------|--------------------------------------|------|-------------------------------------|-----|-------------------------------------|-----|------|
|  | (INFOT)         | (OUTPUT)       | TYP                      | MIN                      | MAX          | MIN                                  | MAX  | MIN                                 | MAX | MIN                                 | MAX |      |
| t <sub>PLH</sub> <sup>(1)</sup>                | А               | В              | 2.7                      | 0.5                      | 5.2          | 0.4                                  | 4.3  | 0.2                                 | 3.4 | 0.2                                 | 3.1 | 20   |
| t <sub>PHL</sub> <sup>(1)</sup>                | ^               | Б              | 2.7                      | 0.5                      | 5.2          | 0.4                                  | 4.3  | 0.2                                 | 3.4 | 0.2                                 | 3.1 | ns   |
| t <sub>PLH</sub> <sup>(1)</sup>                | 0               | ^              | 2.4                      | 0.7                      | 4.7          | 0.5                                  | 4.4  | 0.5                                 | 4   | 0.4                                 | 3.8 | 20   |
| t <sub>PHL</sub> <sup>(1)</sup>                | В               | Α              | 2.4                      | 0.7                      | 4.7          | 0.5                                  | 4.4  | 0.5                                 | 4   | 0.4                                 | 3.8 | ns   |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR             | Α              | 3.7                      | 1.3                      | 8.1          | 0.7                                  | 6.9  | 1.4                                 | 5.3 | 1.1                                 | 5.2 | 20   |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIK             | A              | 3.7                      | 1.3                      | 8.1          | 0.7                                  | 6.9  | 1.4                                 | 5.3 | 1.1                                 | 5.2 | ns   |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR             | В              | 4.4                      | 1.3                      | 5.8          | 1.3                                  | 5.9  | 0.8                                 | 5.7 | 1.5                                 | 5.9 | 20   |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIK             | В              | 4.4                      | 1.3                      | 5.8          | 1.3                                  | 5.9  | 0.8                                 | 5.7 | 1.5                                 | 5.9 | ns   |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DIB             | ^              | 6.8                      |                          | 10.5         |                                      | 10.3 |                                     | 9.7 |                                     | 9.7 | 20   |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | DIR A          | 6.8                      |                          | 10.5         |                                      | 10.3 |                                     | 9.7 |                                     | 9.7 | ns   |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | В              | 6.4                      |                          | 13.3         |                                      | 11.2 |                                     | 8.7 |                                     | 8.3 | 20   |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | אוט             | D              | 6.4                      |                          | 13.3         |                                      | 11.2 |                                     | 8.7 |                                     | 8.3 | ns   |

 $t_{PLH}$ : Low-to-high Propagation Delay;  $t_{PHL}$ : High-to-Low Propagation Delay;  $t_{PHZ}$ : High-to-Hi-Z Propagation Delay;  $t_{PZ}$ : Low-to-Hi-Z Propagation Delay;  $t_{PZ}$ : Hi-Z-to-High Propagation Delay;  $t_{PZ}$ : Hi-Z-to-Low Propagation Delay The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.

### 6.9 Switching Characteristics: $V_{CCA} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range, V<sub>CCA</sub> = 2.5 V ± 0.2 V (see Figure 11)

| PARAMETER                                      | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.2 V | V <sub>CCB</sub> = ± 0.1 | V <sub>CCB</sub> = 1.5 V<br>± 0.1 V |     | V <sub>CCB</sub> = 1.8 V<br>± 0.15 V |     | 2.5 V<br>2 V | V <sub>CCB</sub> = 3.3 V<br>± 0.3 V |     | UNIT |  |
|--|-----------------|----------------|--------------------------|--------------------------|-------------------------------------|-----|--------------------------------------|-----|--------------|-------------------------------------|-----|------|--|
|  | (INPUT)         | (OUTPUT)       | TYP                      | MIN                      | MAX                                 | MIN | MAX                                  | MIN | MAX          | MIN                                 | MAX |      |  |
| t <sub>PLH</sub> <sup>(1)</sup>                | Α               | В              | 2.6                      | 0.4                      | 4.9                                 | 0.2 | 4                                    | 0.2 | 3            | 0.2                                 | 2.6 | no   |  |
| t <sub>PHL</sub> <sup>(1)</sup>                | A               | ь              | 2.6                      | 0.4                      | 4.9                                 | 0.2 | 4                                    | 0.2 | 3            | 0.2                                 | 2.6 | ns   |  |
| t <sub>PLH</sub> <sup>(1)</sup>                | В               | А              | 2.1                      | 0.6                      | 3.8                                 | 0.5 | 3.4                                  | 0.4 | 3            | 0.3                                 | 2.8 | 20   |  |
| t <sub>PHL</sub> <sup>(1)</sup>                | Б               | A              | 2.1                      | 0.6                      | 3.8                                 | 0.5 | 3.4                                  | 0.4 | 3            | 0.3                                 | 2.8 | ns   |  |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR             | Α              | 2.4                      | 0.7                      | 7.9                                 | 0.8 | 6.4                                  | 0.8 | 5            | 0.5                                 | 4.3 | no   |  |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIK             | A              | 2.4                      | 0.7                      | 7.9                                 | 0.8 | 6.4                                  | 0.8 | 5            | 0.5                                 | 4.3 | ns   |  |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR             | В              | 3.8                      | 1                        | 4.3                                 | 0.6 | 4.3                                  | 0.5 | 4.2          | 1.1                                 | 4.1 | no   |  |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIK             | ь              | 3.8                      | 1                        | 4.3                                 | 0.6 | 4.3                                  | 0.5 | 4.2          | 1.1                                 | 4.1 | ns   |  |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | Α              | 5.9                      |                          | 8.5                                 |     | 7.7                                  |     | 7.2          |                                     | 6.9 | no   |  |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIK             | A              | 5.9                      |                          | 8.5                                 |     | 7.7                                  |     | 7.2          |                                     | 6.9 | ns   |  |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | В              | 5                        |                          | 12.8                                |     | 10.4                                 |     | 8            |                                     | 6.9 | no   |  |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | אוט             | D              | 5                        |                          | 12.8                                |     | 10.4                                 |     | 8            |                                     | 6.9 | ns   |  |

t<sub>PLH</sub>: Low-to-high Propagation Delay; t<sub>PHL</sub>: High-to-Low Propagation Delay; t<sub>PHZ</sub>: High-to-Hi-Z Propagation Delay; t<sub>PLZ</sub>: Low-to-Hi-Z Propagation Delay; t<sub>PZ</sub>: Hi-Z-to-High Propagation Delay; t<sub>PZ</sub>: Hi-Z-to-Low Propagation Delay The enable time is a calculated value, derived using the formula shown in the *Enable Times* section.

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### 6.10 Switching Characteristics: V<sub>CCA</sub> = 3.3 V ±0.3 V

over recommended operating free-air temperature range,  $V_{CCA} = 3.3 \text{ V} \pm 0.3 \text{ V}$  (see Figure 11)

| PARAMETER                                      | FROM<br>(INPUT) | TO<br>(OUTPUT) | V <sub>CCB</sub> = 1.2 V |     | V <sub>CCB</sub> = 1.8 V<br>± 0.15 V |     | V <sub>CCB</sub> = 2.5 V<br>± 0.2 V |     | V <sub>CCB</sub> = 3.3 V<br>± 0.3 V |     | UNIT |    |  |
|--|-----------------|----------------|--------------------------|-----|--------------------------------------|-----|-------------------------------------|-----|-------------------------------------|-----|------|----|--|
|  | (INPUT)         | (001701)       | TYP                      | MIN | MAX                                  | MIN | MAX                                 | MIN | MAX                                 | MIN | MAX  |    |  |
| t <sub>PLH</sub> <sup>(1)</sup>                | Α               | В              | 2.5                      | 0.3 | 4.7                                  | 0.2 | 3.8                                 | 0.2 | 2.8                                 | 0.2 | 2.4  | 20 |  |
| t <sub>PHL</sub> <sup>(1)</sup>                | A               | В              | 2.5                      | 0.3 | 4.7                                  | 0.2 | 3.8                                 | 0.2 | 2.8                                 | 0.2 | 2.4  | ns |  |
| t <sub>PLH</sub> <sup>(1)</sup>                | Б               | ^              | 2.1                      | 0.6 | 3.6                                  | 0.4 | 3.1                                 | 0.3 | 2.6                                 | 0.3 | 2.4  |    |  |
| t <sub>PHL</sub> <sup>(1)</sup>                | В               | Α              | 2.1                      | 0.6 | 3.6                                  | 0.4 | 3.1                                 | 0.3 | 2.6                                 | 0.3 | 2.4  | ns |  |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DIR             | ^              | 2.9                      | 1.1 | 8                                    | 1   | 6.5                                 | 1.3 | 4.7                                 | 1.2 | 4    | 20 |  |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIK             | Α              | 2.9                      | 1.1 | 8                                    | 1   | 6.5                                 | 1.3 | 4.7                                 | 1.2 | 4    | ns |  |
| t <sub>PHZ</sub> <sup>(1)</sup>                | DID             | Б              | 3.4                      | 0.5 | 6.6                                  | 0.3 | 5.6                                 | 0.3 | 4.6                                 | 1.1 | 4.2  |    |  |
| t <sub>PLZ</sub> <sup>(1)</sup>                | DIR             | В              | 3.4                      | 0.5 | 6.6                                  | 0.3 | 5.6                                 | 0.3 | 4.6                                 | 1.1 | 4.2  | ns |  |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DID             | ^              | 5.5                      |     | 10.2                                 |     | 8.7                                 |     | 7.2                                 |     | 6.6  |    |  |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | Α              | 5.5                      |     | 10.2                                 |     | 8.7                                 |     | 7.2                                 |     | 6.6  | ns |  |
| t <sub>PZH</sub> <sup>(1)</sup> <sup>(2)</sup> | DID             | В              | 5.4                      |     | 12.7                                 |     | 10.3                                |     | 7.5                                 |     | 6.4  | 20 |  |
| t <sub>PZL</sub> <sup>(1)</sup> <sup>(2)</sup> | DIR             | В              | 5.4                      |     | 12.7                                 |     | 10.3                                |     | 7.5                                 |     | 6.4  | ns |  |

 $t_{PLH}$ : Low-to-high Propagation Delay;  $t_{PHL}$ : High-to-Low Propagation Delay;  $t_{PHZ}$ : High-to-Hi-Z Propagation Delay;  $t_{PZL}$ : Hi-Z-to-Low Propagation Delay;  $t_{PZL}$ : Hi-Z-to-Low Propagation Delay The enable time is a calculated value, derived using the formula shown in the section.

### 6.11 Operating Characteristics

 $T_A = 25^{\circ}C$ 

| PARAMETER                       |                                | TEST<br>CONDITIONS                                     | V <sub>CCA</sub> = V <sub>CCB</sub> = 1.2 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 1.5 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 1.8 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 2.5 V | V <sub>CCA</sub> = V <sub>CCB</sub> = 3.3 V | UNIT |
|---------------------------------|--------------------------------|--|---|---|---|---|---|------|
| <b>C</b> (1)                    | A-port input,<br>B-port output | $C_L = 0$ ,  | 3   | 3   | 3   | 3   | 4   | F    |
| C <sub>pdA</sub> (1)            | B-port input,<br>A-port output | f = 10  MHz,<br>$t_r^{(2)} = t_f^{(2)} = 1 \text{ ns}$ | 12  | 13  | 13  | 14  | 15  | pF   |
| C (1)                           | A-port input,<br>B-port output | $C_L = 0,$   | 12  | 13  | 13  | 14  | 15  | 5.   |
| C <sub>pdB</sub> <sup>(1)</sup> | B-port input,<br>A-port output | f = 10  MHz,<br>$t_r^{(2)} = t_f^{(2)} = 1 \text{ ns}$ | 3   | 3   | 3   | 3   | 4   | pF   |

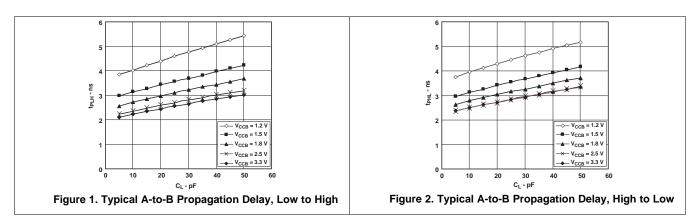
Power-dissipation capacitance per transceiver

t<sub>r</sub>: Rise time; t<sub>f</sub>: Fall time

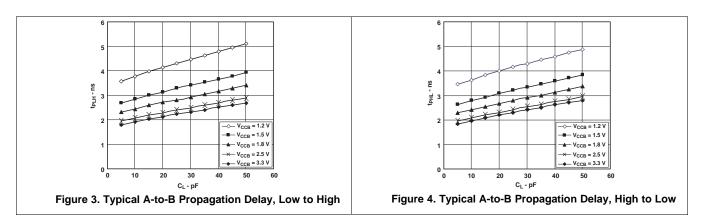
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### 6.12 Typical Characteristics

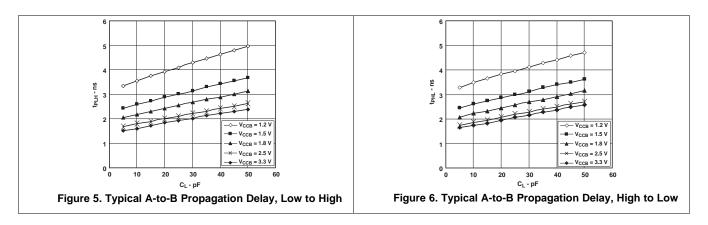
### 6.12.1 Typical Propagation Delay (A to B) vs Load Capacitance, $T_A = 25$ °C, $V_{CCA} = 1.2 \text{ V}$



### 6.12.2 Typical Propagation Delay (A to B) vs Load Capacitance, $T_A = 25$ °C, $V_{CCA} = 1.5 \text{ V}$



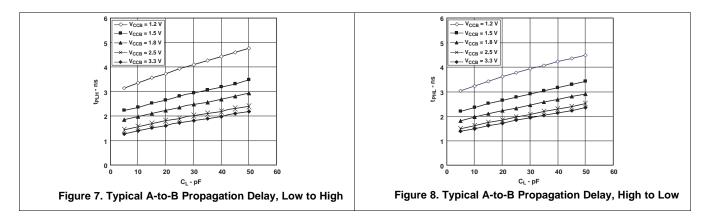
### 6.12.3 Typical Propagation Delay (A-to-B) vs Load Capacitance, $T_A = 25$ °C, $V_{CCA} = 1.8 \text{ V}$



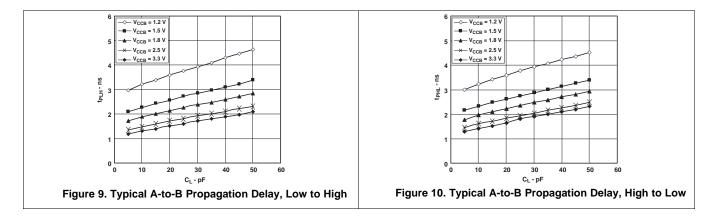
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### 6.12.4 Typical Propagation Delay (A to B) vs Load Capacitance, $T_A = 25$ °C, $V_{CCA} = 2.5$ V



### 6.12.5 Typical Propagation Delay (A to B) vs Load Capacitance, T<sub>A</sub> = 25°C, V<sub>CCA</sub> = 3.3 V

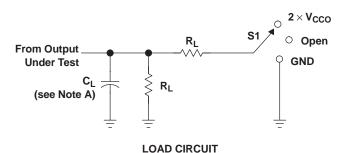


Product Folder Links: SN74AVC2T45

 $V_{\text{CCA}}$ 

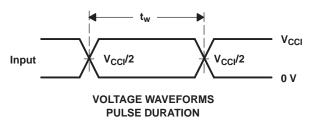


#### 7 Parameter Measurement Information



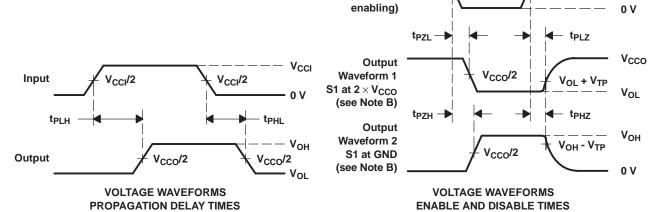
| TEST  | S1                      |
|---|-------------------------|
| t <sub>pd</sub><br>t <sub>PLZ</sub> /t <sub>PZL</sub> | Open 2×V <sub>CCO</sub> |
| t <sub>PHZ</sub> /t <sub>PZH</sub>                    | GND                     |

| V <sub>CCO</sub>   | CL    | R <sub>L</sub> | V <sub>TP</sub> |
|--------------------|-------|----------------|-----------------|
| 1.2 V              | 15 pF | <b>2 k</b> Ω   | 0.1 V           |
| 1.5 V $\pm$ 0.1 V  | 15 pF | <b>2 k</b> Ω   | 0.1 V           |
| 1.8 V $\pm$ 0.15 V | 15 pF | <b>2 k</b> Ω   | 0.15 V          |
| 2.5 V $\pm$ 0.2 V  | 15 pF | <b>2 k</b> Ω   | 0.15 V          |
| 33V+03V            | 15 nF | 2 kO           | 03V             |



V<sub>CCA</sub>/2

V<sub>CCA</sub>/2



Output Control

(low-level

NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_0 = 50 \ \Omega$ ,  $dv/dt \geq$  1 V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t<sub>PLZ</sub> and t<sub>PHZ</sub> are the same as t<sub>dis</sub>.
- F. t<sub>PZL</sub> and t<sub>PZH</sub> are the same as t<sub>en</sub>.
- G.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- H.  $V_{CCI}$  is the  $V_{CC}$  associated with the input port.
- I.  $V_{CCO}$  is the  $V_{CC}$  associated with the output port.

Figure 11. Load Circuit and Voltage Waveforms

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### 8 Detailed Description

#### 8.1 Overview

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track  $V_{CCA}$  and accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track  $V_{CCB}$  and accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation and level-shifting between any of the 1.2 V, 1.5 V, 1.8 V, 2.5 V, and 3.3 V voltage nodes.

The SN74AVC2T45 is designed for asynchronous communication between two data buses. The logic levels of the direction-control (DIR) input activate either the B-port outputs or the A-port outputs. The device transmits data from the A bus to the B bus when the B-port outputs are activated and from the B bus to the A bus when the A-port outputs are activated. The input circuitry on both A and B ports always is active and must have a logic HIGH or LOW level applied to prevent excess internal leakage of the CMOS.

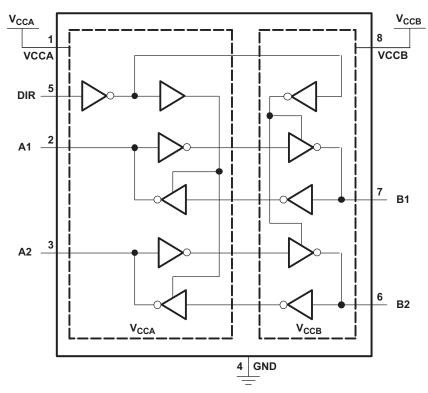
The SN74AVC2T45 is designed so that the DIR input is powered by supply voltage from VCCA.

This device is fully specified for partial-power-down applications using off output current ( $I_{off}$ ). The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The  $V_{CC}$  isolation feature ensures that if either VCC input is at GND, both ports are put in a high-impedance state. This will prevent a false high or low logic being presented at the output.

NanoFree package technology is a major breakthrough in IC packaging concepts, using the die as the package.

### 8.2 Functional Block Diagram



Pin numbers are for the DCT and DCU packages only.

Figure 12. Logic Diagram (Positive Logic)



#### 8.3 Feature Description

#### 8.3.1 VCC Isolation

The  $V_{CC}$  isolation feature ensures that if either  $V_{CCA}$  or  $V_{CCB}$  are at GND, both ports will be in a high-impedance state ( $I_{OZ}$  shown in *Electrical Characteristics*). This prevents false logic levels from being presented to either bus.

#### 8.3.2 2-Rail Design

Fully configurable 2-rail design allows each port to operate over the full 1.2 V to 3.6 V power-supply range.

#### 8.3.3 IO Ports are 4.6 V Tolerant

The IO ports are up to 4.6 V tolerant

#### 8.3.4 Partial-Power-Down Mode

This device is fully specified for partial-power-down applications using off output current (I<sub>off</sub>). The I<sub>off</sub> circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

#### 8.4 Device Functional Modes

Table 2. Function Table<sup>(1)</sup> (Each Transceiver)

| INPUT<br>DIR | OPERATION       |
|--------------|-----------------|
| L            | B data to A bus |
| Н            | A data to B bus |

(1) Input circuits of the data IOs always are active.

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### 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The SN74AVC2T45 is used to shift IO voltage levels from one voltage domain to another. Bus A and bus B have independent power supplies, and a direction pin is used to control the direction of data flow. Unused data ports must not be floating; tie the unused port input and output to ground directly.

### 9.2 Typical Applications

### 9.2.1 Unidirectional Logic Level-Shifting Application

Figure 13 is an example circuit of the SN74AVC2T45 used in a unidirectional logic level-shifting application.

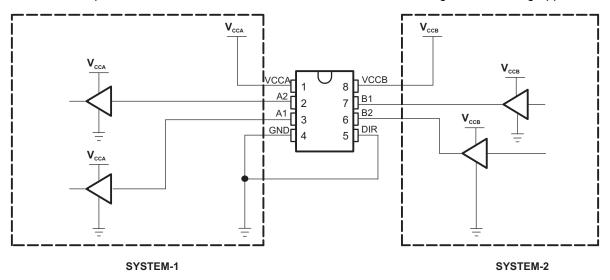


Figure 13. Unidirectional Logic Level-Shifting Application

#### 9.2.1.1 Design Requirements

| PIN | NAME | DESCRIPTION  |
|-----|------|--|
| 1   | VCCA | SYSTEM-1 supply voltage (1.2 V to 3.6 V)                   |
| 2   | A1   | Output level depends on V <sub>CCA</sub> .                 |
| 3   | A2   | Output level depends on V <sub>CCA</sub> .                 |
| 4   | GND  | Device GND   |
| 5   | DIR  | The GND (low-level) determines B-port to A-port direction. |
| 6   | B2   | Input threshold value depends on V <sub>CCB</sub> .        |
| 7   | B1   | Input threshold value depends on V <sub>CCB</sub> .        |
| 8   | VCCB | SYSTEM-2 supply voltage (1.2 V to 3.6 V)                   |



#### 9.2.1.2 Detailed Design Procedure

This device uses drivers which are enabled depending on the state of the DIR pin. The designer must know the intended flow of data and take care not to violate any of the high or low logic levels. Unused data inputs must not be floating, as this can cause excessive internal leakage on the input CMOS structure. Make sure to tie any unused input and output ports directly to ground.

#### 9.2.1.3 Application Curves

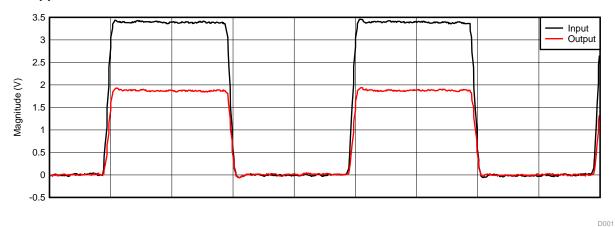


Figure 14. 3.3 V to 1.8 V Level-Shifting With 1-MHz Square Wave

### 9.2.2 Bidirectional Logic Level-Shifting Application

Figure 15 shows the SN74AVC2T45 used in a bidirectional logic level-shifting application.

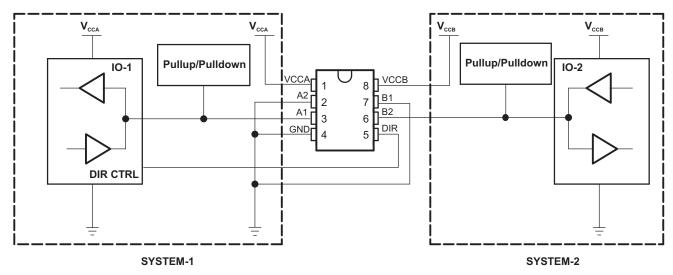


Figure 15. Bidirectional Logic Level-Shifting Application

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#### 9.2.2.1 Design Requirements

The SN74AVC2T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.

#### 9.2.2.2 Detailed Design Procedure

Following is a sequence that illustrates data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-1.

| STATE | DIR CTRL | IO-1   | IO-2   | DESCRIPTION   |
|-------|----------|--------|--------|---|
| 1     | Н        | Output | Input  | SYSTEM-1 data to SYSTEM-2   |
| 2     | Н        | Hi-Z   | Hi-Z   | SYSTEM-2 is getting ready to send data to SYSTEM-1. IO-1 and IO-2 are disabled. The bus-line state depends on pullup or pulldown. (1) |
| 3     | L        | Hi-Z   | Hi-Z   | DIR bit is flipped. IO-1 and IO-2 still are disabled.<br>The bus-line state depends on pullup or pulldown. (1)                        |
| 4     | L        | Input  | Output | SYSTEM-2 data to SYSTEM-1   |

<sup>(1)</sup> SYSTEM-1 and SYSTEM-2 must use the same conditions, i.e., both pullup or both pulldown.

#### 9.2.2.2.1 Enable Times

Calculate the enable times for the SN74AVC2T45 using the following formulas:

- $t_{PZH}$  (DIR to A) =  $t_{PLZ}$  (DIR to B) +  $t_{PLH}$  (B to A)
- $t_{PZL}$  (DIR to A) =  $t_{PHZ}$  (DIR to B) +  $t_{PHL}$  (B to A)
- $t_{PZH}$  (DIR to B) =  $t_{PLZ}$  (DIR to A) +  $t_{PLH}$  (A to B)
- $t_{PZL}$  (DIR to B) =  $t_{PHZ}$  (DIR to A) +  $t_{PHL}$  (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC2T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.



### 10 Power Supply Recommendations

A proper power-up sequence always should be followed to avoid excessive current on the supply pin, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up V<sub>CCA</sub>.
- 3.  $V_{CCB}$  can be ramped up along with or after  $V_{CCA}$ .

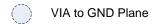
### 11 Layout

#### 11.1 Layout Guidelines

To ensure reliability of the device, following common printed-circuit board layout guidelines is recommended.

- Bypass capacitors should be used on power supplies. Place the capacitors as close as possible to the VCCA, VCCB pin and GND pin.
- Short trace lengths should be used to avoid excessive loading.

### 11.2 Layout Example



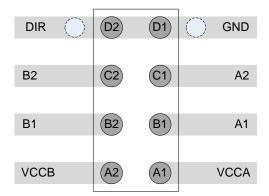


Figure 16. Layout Example for YZP Package

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### 12 Device and Documentation Support

### 12.1 Documentation Support

#### 12.1.1 Related Documentation

Implications of Slow or Floating CMOS Inputs, SCBA004

#### 12.2 Trademarks

NanoFree is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 12.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 12.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





17-Aug-2015

#### PACKAGING INFORMATION

| Orderable Device  | Status | Package Type | _       |   | _    | Eco Plan                   | Lead/Ball Finish  | MSL Peak Temp      | Op Temp (°C) | Device Marking    | Samples |
|-------------------|--------|--------------|---------|---|------|----------------------------|-------------------|--------------------|--------------|-------------------|---------|
|                   | (1)    |              | Drawing |   | Qty  | (2)                        | (6)               | (3)                |              | (4/5)             |         |
| SN74AVC2T45DCTR   | ACTIVE | SM8          | DCT     | 8 | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2<br>Z          | Samples |
| SN74AVC2T45DCTRE4 | ACTIVE | SM8          | DCT     | 8 | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2<br>Z          | Samples |
| SN74AVC2T45DCTT   | ACTIVE | SM8          | DCT     | 8 | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2<br>Z          | Samples |
| SN74AVC2T45DCTTG4 | ACTIVE | SM8          | DCT     | 8 | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2<br>Z          | Samples |
| SN74AVC2T45DCUR   | ACTIVE | VSSOP        | DCU     | 8 | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU   CU SN | Level-1-260C-UNLIM | -40 to 85    | (DT2R ~ T2)<br>DZ | Samples |
| SN74AVC2T45DCURE4 | ACTIVE | VSSOP        | DCU     | 8 |      | TBD                        | Call TI           | Call TI            | -40 to 85    |                   | Samples |
| SN74AVC2T45DCURG4 | ACTIVE | VSSOP        | DCU     | 8 | 3000 | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2R              | Samples |
| SN74AVC2T45DCUT   | ACTIVE | VSSOP        | DCU     | 8 | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2R              | Samples |
| SN74AVC2T45DCUTE4 | ACTIVE | VSSOP        | DCU     | 8 |      | TBD                        | Call TI           | Call TI            | -40 to 85    |                   | Samples |
| SN74AVC2T45DCUTG4 | ACTIVE | VSSOP        | DCU     | 8 | 250  | Green (RoHS<br>& no Sb/Br) | CU NIPDAU         | Level-1-260C-UNLIM | -40 to 85    | DT2R              | Samples |
| SN74AVC2T45YZPR   | ACTIVE | DSBGA        | YZP     | 8 | 3000 | Green (RoHS<br>& no Sb/Br) | SNAGCU            | Level-1-260C-UNLIM | -40 to 85    | (TD7 ~ TDN)       | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.



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### PACKAGE OPTION ADDENDUM

17-Aug-2015

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead/Ball Finish Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN74AVC2T45:

Automotive: SN74AVC2T45-Q1

NOTE: Qualified Version Definitions:

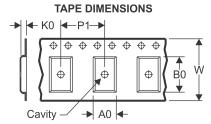
Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

### PACKAGE MATERIALS INFORMATION

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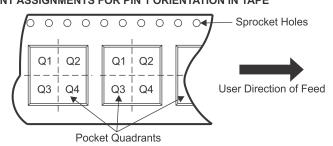
### TAPE AND REEL INFORMATION





| A0 | Dimension designed to accommodate the component width     |
|----|---|
|    | Dimension designed to accommodate the component length    |
| K0 | Dimension designed to accommodate the component thickness |
| W  | Overall width of the carrier tape                         |
| P1 | Pitch between successive cavity centers                   |

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

| Device            | Package<br>Type | Package<br>Drawing |   | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
|-------------------|-----------------|--------------------|---|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| SN74AVC2T45DCTR   | SM8             | DCT                | 8 | 3000 | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| SN74AVC2T45DCTT   | SM8             | DCT                | 8 | 250  | 180.0                    | 13.0                     | 3.35       | 4.5        | 1.55       | 4.0        | 12.0      | Q3               |
| SN74AVC2T45DCUR   | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| SN74AVC2T45DCUR   | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 9.0                      | 2.05       | 3.3        | 1.0        | 4.0        | 8.0       | Q3               |
| SN74AVC2T45DCURG4 | VSSOP           | DCU                | 8 | 3000 | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| SN74AVC2T45DCUTG4 | VSSOP           | DCU                | 8 | 250  | 180.0                    | 8.4                      | 2.25       | 3.35       | 1.05       | 4.0        | 8.0       | Q3               |
| SN74AVC2T45YZPR   | DSBGA           | YZP                | 8 | 3000 | 178.0                    | 9.2                      | 1.02       | 2.02       | 0.63       | 4.0        | 8.0       | Q1               |

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\*All dimensions are nominal

| Device            | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74AVC2T45DCTR   | SM8          | DCT             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| SN74AVC2T45DCTT   | SM8          | DCT             | 8    | 250  | 182.0       | 182.0      | 20.0        |
| SN74AVC2T45DCUR   | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AVC2T45DCUR   | VSSOP        | DCU             | 8    | 3000 | 182.0       | 182.0      | 20.0        |
| SN74AVC2T45DCURG4 | VSSOP        | DCU             | 8    | 3000 | 202.0       | 201.0      | 28.0        |
| SN74AVC2T45DCUTG4 | VSSOP        | DCU             | 8    | 250  | 202.0       | 201.0      | 28.0        |
| SN74AVC2T45YZPR   | DSBGA        | YZP             | 8    | 3000 | 220.0       | 220.0      | 35.0        |

### DCT (R-PDSO-G8)

#### PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion
- D. Falls within JEDEC MO-187 variation DA.

### DCT (R-PDSO-G8)

### PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



# DCU (R-PDSO-G8)

# PLASTIC SMALL-OUTLINE PACKAGE (DIE DOWN)



NOTES:

- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-187 variation CA.



DCU (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE (DIE DOWN)



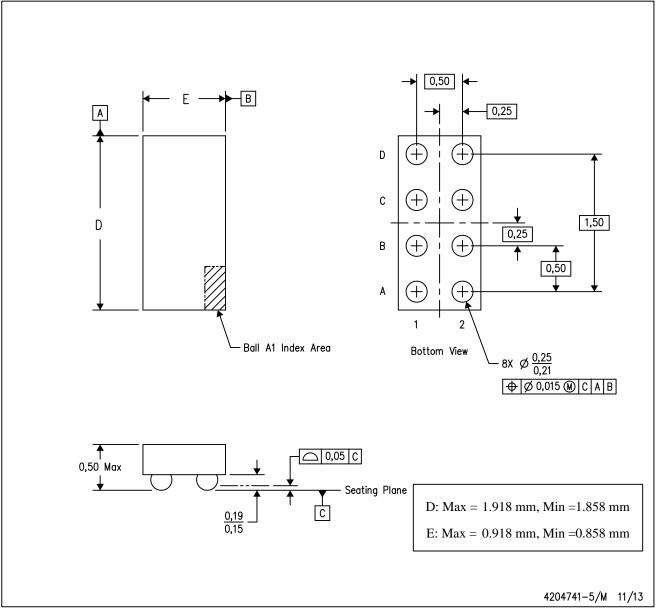
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Publication IPC-7351 is recommended for alternate designs.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. NanoFree™ package configuration.

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